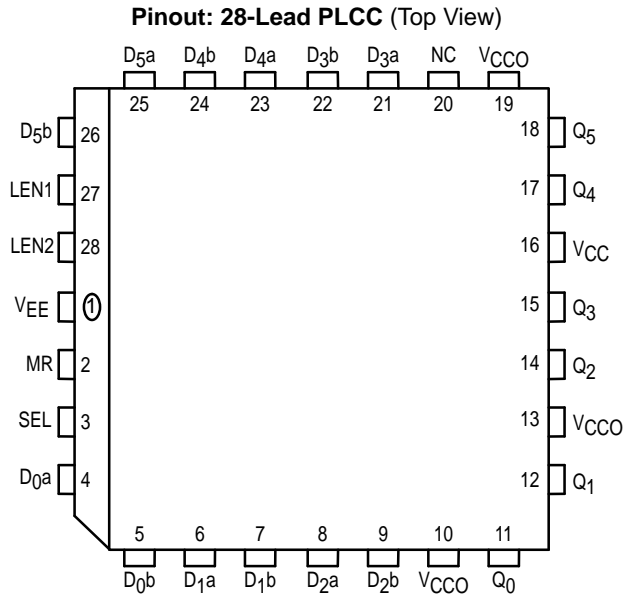


## 6-Bit 2:1 Mux-Latch

The MC10E100E155 contains six 2:1 multiplexers followed by transparent latches with single-ended outputs. When both Latch Enables (LEN1, LEN2) are LOW, the latch is transparent, and output data is controlled by the multiplexer select control, SEL. A logic HIGH on either LEN1 or LEN2 (or both) latches the outputs. The Master Reset (MR) overrides all other controls to set the Q outputs LOW.

- 850ps Max. LEN to Output
- 825ps Max. D to Output
- Single-Ended Outputs
- Asynchronous Master Reset
- Dual Latch-Enables
- Extended 100E  $V_{EE}$  Range of - 4.2V to - 5.46V
- 75k $\Omega$  Input Pulldown Resistors



\* All VCC and VCCO pins are tied together on the die.

### PIN NAMES

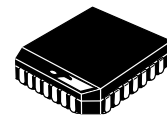
Pin	Function
D0a - D04	Input Data a
D0b - D4b	
SEL	Data Select Input
LEN1, LEN2	Latch Enables
MR	Master Reset
Q0 - Q4	Outputs

### TRUTH TABLE

SEL	Data
H	a
L	b

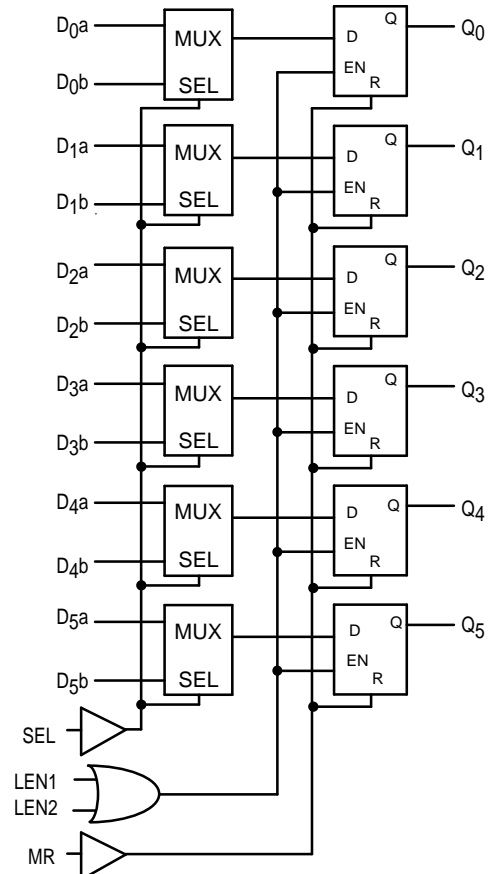
**MC10E155**  
**MC100E155**

**6-BIT 2:1**  
**MUX-LATCH**



**FN SUFFIX**  
PLASTIC PACKAGE  
CASE 776-02

### LOGIC DIAGRAM



MC10E155 MC100E155

**DC CHARACTERISTICS** ( $V_{EE} = V_{EE}(\text{min})$  to  $V_{EE}(\text{max})$ ;  $V_{CC} = V_{CCO} = \text{GND}$ )

Symbol	Characteristic	0°C			25°C			85°C			Unit	Condition
		min	typ	max	min	typ	max	min	typ	max		
$I_{IH}$	Input HIGH Current			150			150			150	$\mu\text{A}$	
$I_{EE}$	Power Supply Current										$\text{mA}$	
	10E		85	102		85	102		85	102		
	100E		85	102		85	102		98	117		

**AC CHARACTERISTICS** ( $V_{EE} = V_{EE}(\text{min})$  to  $V_{EE}(\text{max})$ ;  $V_{CC} = V_{CCO} = \text{GND}$ )

Symbol	Characteristic	0°C			25°C			85°C			Unit	Condition
		min	typ	max	min	typ	max	min	typ	max		
$t_{PLH}$ $t_{PHL}$	Propagation Delay to Output										$\text{ps}$	
	D	325	500	700	325	500	700	325	500	700		
	SEL	475	675	925	475	675	925	475	675	925		
	LEN	350	500	750	350	500	750	350	500	750		
	MR	450	600	850	450	600	850	450	600	850		
$t_s$	Setup Time										$\text{ps}$	
	D	300	100		300	100		300	100			
	SEL	500	250		500	250		500	250			
$t_h$	Hold Time										$\text{ps}$	
	D	300	-100		300	-100		300	-100			
	SEL	0	-250		0	-250		0	-250			
$t_{RR}$	Reset Recovery Time	800	650		800	650		800	650		$\text{ps}$	
$t_{PW}$	Minimum Pulse Width										$\text{ps}$	
	MR	400			400			400				
$t_{SKEW}$	Within-Device Skew		75			75			75		$\text{ps}$	1
$t_r$ $t_f$	Rise/Fall Times										$\text{ps}$	
	20 - 80%	300	450	800	300	450	800	300	450	800		

1. Within-device skew is defined as identical transitions on similar paths through a device.

OUTLINE DIMENSIONS


FN SUFFIX  
 PLASTIC PLCC PACKAGE  
 CASE 776-02  
 ISSUE D



NOTES:

- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
- DIM G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIM R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.485	0.495	12.32	12.57
B	0.485	0.495	12.32	12.57
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	—	0.51	—
K	0.025	—	0.64	—
R	0.450	0.456	11.43	11.58
U	0.450	0.456	11.43	11.58
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	—	0.020	—	0.50
Z	2°		10°	
G1	0.410	0.430	10.42	10.92
K1	0.040	—	1.02	—

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**How to reach us:**

**USA/EUROPE/Locations Not Listed:** Motorola Literature Distribution;  
P.O. Box 20912; Phoenix, Arizona 85036. 1-800-441-2447 or 602-303-5454

**MFAX:** RMFAX0@email.sps.mot.com – TOUCHTONE 602-244-6609  
**INTERNET:** <http://Design-NET.com>

**JAPAN:** Nippon Motorola Ltd.; Tatsumi-SPD-JLDC, 6F Seibu-Butsuryu-Center,  
3-14-2 Tatsumi Koto-Ku, Tokyo 135, Japan. 03-81-3521-8315

**ASIA/PACIFIC:** Motorola Semiconductors H.K. Ltd.; 8B Tai Ping Industrial Park,  
51 Ting Kok Road, Tai Po, N.T., Hong Kong. 852-26629298

